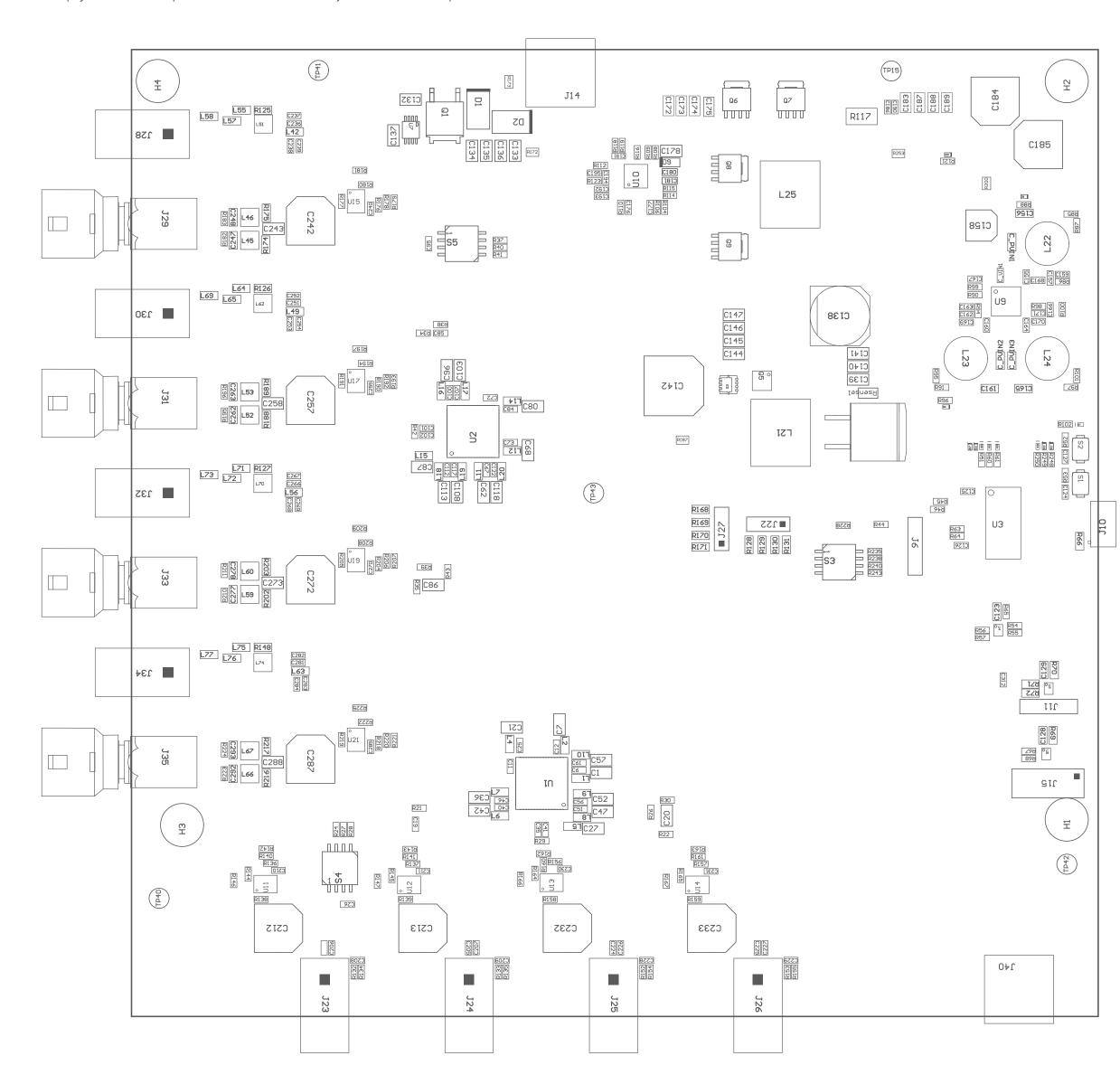
ZZI Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

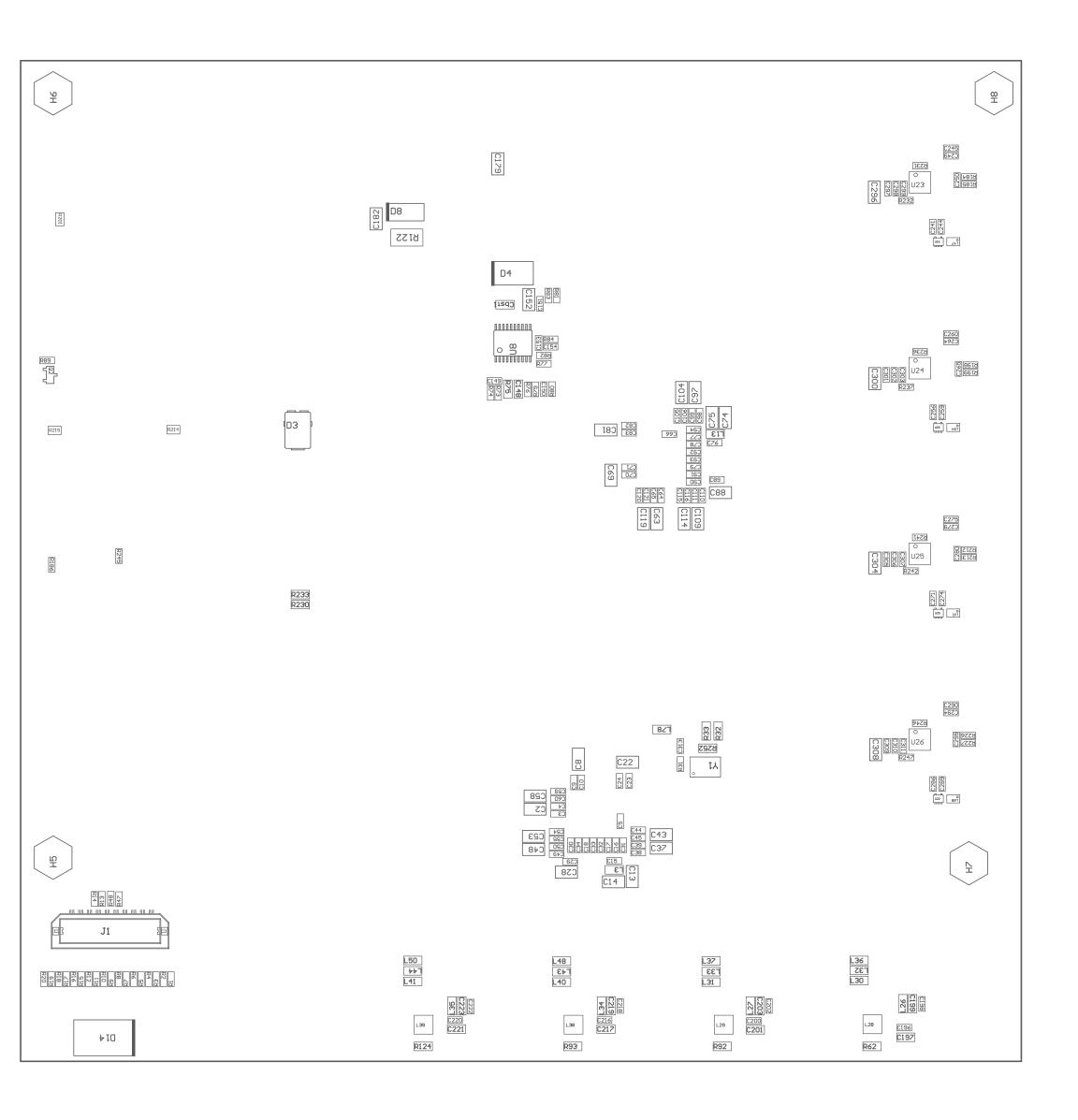
ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Populated_variant

PCB VIEWED FROM TOP SIDE	BOARD #: 518520B	REV: B	SUN REV:	Not In VersionControl	
	TID #: N/A				
PLOT NAME = Top Assembly Drawing	GENERATED : 1/5/20	18 2: 37: 32	PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: Populated_variant

PCB VIEWED FROM BOTTOM SIDE	BOARD #: 518520B	REV: B	SUN REV:	Not In VersionControl	
	TID #: N/A				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 1/5/20	18 2:37:32	PM	TEXAS INSTRUMENTS	

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